



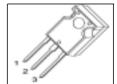
Cool MOS™ Power Transistor

Feature

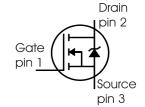
- New revolutionary high voltage technology
- Ultra low gate charge
- Periodic avalanche rated
- Extreme dv/dt rated
- Ultra low effective capacitances
- Improved transconductance
- Pb-free lead plating; RoHS compliant
- Qualified according to JEDEC⁰⁾ for target applications

V _{DS} @ T _{jmax}	650	٧
R _{DS(on)}	0.28	Ω
/ _D	15	Α





Туре	Package	Ordering Code	Marking
SPW15N60C3	PG-TO247	Q67040-S4604	15N60C3



Maximum Ratings

Parameter	Symbol	Value	Unit
Continuous drain current	I_{D}		Α
$T_{\rm C}$ = 25 °C		15	
T _C = 100 °C		9.4	
Pulsed drain current, t_p limited by T_{jmax}	I _{D puls}	45	
Avalanche energy, single pulse	E _{AS}	460	mJ
$I_{\rm D}$ = 7.5 A, $V_{\rm DD}$ = 50 V			
Avalanche energy, repetitive t_{AR} limited by T_{jmax} ¹	E _{AR}	0.8	
$I_{\rm D}$ = 15 A, $V_{\rm DD}$ = 50 V			
Avalanche current, repetitive t_{AR} limited by T_{jmax}	I _{AR}	15	Α
Reverse diode dv/dt ⁴⁾	dv/dt	15	V/ns
Gate source voltage static	V_{GS}	±20	V
Gate source voltage AC (f >1Hz)	V_{GS}	±30	
Power dissipation, $T_{\text{C}} = 25^{\circ}\text{C}$	P_{tot}	156	W
Operating and storage temperature	T _j , T _{stg}	-55 +150	°C



Maximum Ratings

Parameter	Symbol	Value	Unit
Drain Source voltage slope	d <i>v</i> /d <i>t</i>	50	V/ns
$V_{\rm DS}$ = 480 V, $I_{\rm D}$ = 15 A, $T_{\rm j}$ = 125 °C			

Thermal Characteristics

Parameter	Symbol	Values			Unit
		min.	typ.	max.	
Thermal resistance, junction - case	R _{thJC}	-	-	0.8	K/W
Thermal resistance, junction - ambient, leaded	R_{thJA}	-	-	62	
Soldering temperature, wavesoldering	T_{sold}	-	-	260	°C
1.6 mm (0.063 in.) from case for 10s					

Electrical Characteristics, at Tj=25°C unless otherwise specified

Parameter	Symbol	Conditions		Values		Unit
			min.	typ.	max.	
Drain-source breakdown voltage	V _{(BR)DSS}	V _{GS} =0V, I _D =0.25mA	600	-	-	V
Drain-Source avalanche	V _{(BR)DS}	V _{GS} =0V, I _D =15A	-	700	-	
breakdown voltage	, ,					
Gate threshold voltage	V _{GS(th)}	$I_{\rm D}$ =675 $\mu{\rm A}, V_{\rm GS}$ = $V_{\rm DS}$	2.1	3	3.9	
Zero gate voltage drain current	I _{DSS}	V _{DS} =600V, V _{GS} =0V,				μA
		<i>T</i> _j =25°C,	-	0.1	1	
		<i>T</i> _j =150°C	-	-	100	
Gate-source leakage current	I _{GSS}	V _{GS} =30V, V _{DS} =0V	-	-	100	nA
Drain-source on-state resistance	R _{DS(on)}	V _{GS} =10V, I _D =9.4A,				Ω
	, ,	<i>T</i> _j =25°C	-	0.25	0.28	
		<i>T</i> _j =150°C	-	0.68	-	
Gate input resistance	R _G	f=1MHz, open Drain	-	1.23	-	



Electrical Characteristics, at $T_i = 25$ °C, unless otherwise specified

Parameter	Symbol	mbol Conditions		Values		
			min.	typ.	max.	1
Transconductance	<i>g</i> fs	V _{DS} ≥2*I _D *R _{DS(on)max} ,	-	11.9	-	S
		I _D =9.4A				
Input capacitance	C _{iss}	V _{GS} =0V, V _{DS} =25V,	-	1660	-	pF
Output capacitance	Coss	f=1MHz	-	540	-	
Reverse transfer capacitance	C _{rss}		-	40	-	
Effective output capacitance,2)		V _{GS} =0V,	-	80	-	pF
energy related	, ,	V _{DS} =0V to 480V				
Effective output capacitance,3)	C _{o(tr)}		-	127	-	
time related	, ,					
Turn-on delay time	t _{d(on)}	V _{DD} =380V, V _{GS} =0/10V,	-	10	-	ns
Rise time	t _r	$I_{\rm D}$ =15A, $R_{\rm G}$ =4.3 Ω	-	5	-	
Turn-off delay time	t _{d(off)}		-	50	80	
Fall time	<i>t</i> _f		-	5	10	

Gate Charge Characteristics

_						
Gate to source charge	Q _{gs}	V _{DD} =480V, I _D =15A	-	7	-	nC
Gate to drain charge	Q _{gd}		-	29	-	
Gate charge total	Qg	V _{DD} =480V, I _D =15A,	-	63	-	1
		V _{GS} =0 to 10V				
Gate plateau voltage	V _(plateau)	V _{DD} =480V, I _D =15A	-	5	-	V

⁰J-STD20 and JESD22

¹Repetitve avalanche causes additional power losses that can be calculated as $P_{\text{AV}} = E_{\text{AR}} * f$.

 $^{^2}C_{\mathrm{o(er)}}$ is a fixed capacitance that gives the same stored energy as C_{oss} while V_{DS} is rising from 0 to 80% V_{DSS} .

 $^{^3}C_{
m o(tr)}$ is a fixed capacitance that gives the same charging time as $C_{
m oss}$ while $V_{
m DS}$ is rising from 0 to 80% $V_{
m DSS}$.

 $^{^4}$ I_{SD}<=I_D, di/dt<=400A/us, V_{DClink}=400V, V_{peak}<V_{BR, DSS}, T_j<T_{j,max}. Identical low-side and high-side switch.

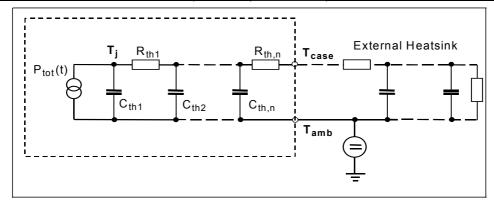


Electrical Characteristics, at T_j = 25 °C, unless otherwise specified

Parameter	Symbol	Conditions	Values			Unit
			min.	typ.	max.	
Inverse diode continuous	IS	<i>T</i> _C =25°C	-	-	15	Α
forward current						
Inverse diode direct current,	I _{SM}		-	-	45	
pulsed						
Inverse diode forward voltage	V_{SD}	V _{GS} =0V, I _F =I _S	-	1	1.2	V
Reverse recovery time	t_{rr}	V _R =480V, I _F =I _S ,	-	460	-	ns
Reverse recovery charge	Q _{rr}	d <i>i</i> _F /d <i>t</i> =100A/μs	-	27	-	μC
Peak reverse recovery current	/ _{rrm}		-	55	-	Α
Peak rate of fall of reverse	di _{rr} /dt		-	tbd	-	A/µs
recovery current						

Typical Transient Thermal Characteristics

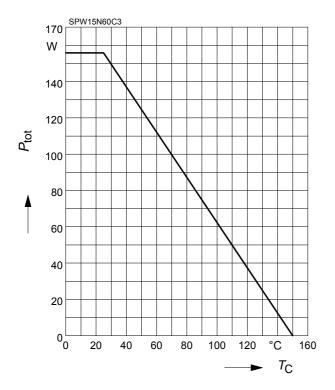
Symbol	Value	Unit	Symbol	Value	Unit
	typ.			typ.	
Thermal r	esistance	·	Thermal of	capacitance	
R _{th1}	0.012	K/W	C _{th1}	0.0002495	Ws/K
R _{th2}	0.023		C _{th2}	0.0009406	
R _{th3}	0.043		C _{th3}	0.001298	
R _{th4}	0.156		C _{th4}	0.00362	
R _{th5}	0.178		C _{th5}	0.009046	
R _{th6}	0.072	\neg	C _{th6}	0.412	





1 Power dissipation

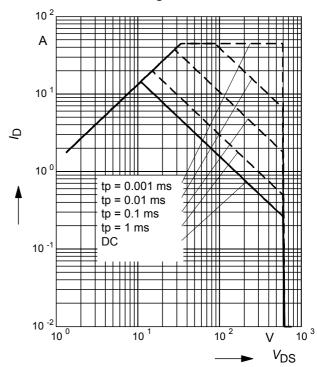
$$P_{\text{tot}} = f(T_{\text{C}})$$



2 Safe operating area

$$I_{\mathsf{D}} = f (V_{\mathsf{DS}})$$

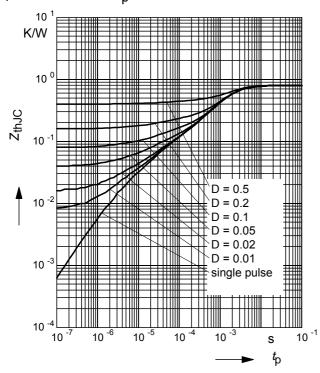
parameter : D = 0 , $T_C = 25$ °C



3 Transient thermal impedance

$$Z_{\text{thJC}} = f(t_{\text{p}})$$

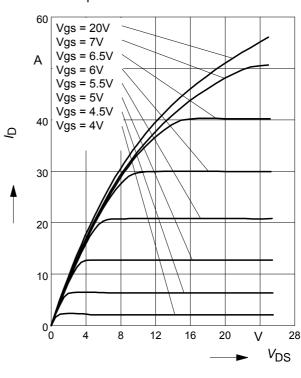
parameter: $D = t_D/T$



4 Typ. output characteristic

 $I_{D} = f(V_{DS}); T_{j}=25^{\circ}C$

parameter: $t_p = 10 \mu s$, V_{GS}

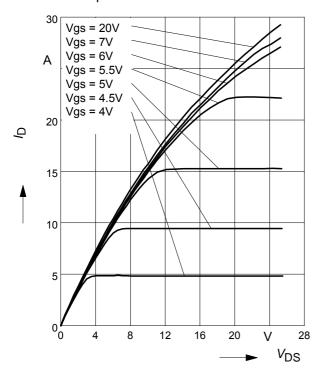


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5 Typ. output characteristic

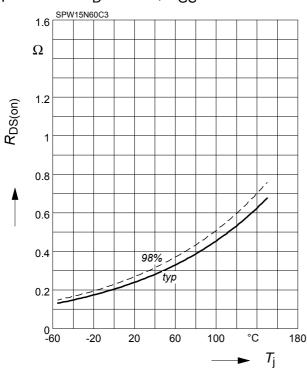
 $I_{\rm D} = f(V_{\rm DS}); T_{\rm j} = 150 ^{\circ} {\rm C}$ parameter: $t_{\rm p} = 10 \ \mu {\rm s}, \ V_{\rm GS}$



7 Drain-source on-state resistance

 $R_{\mathrm{DS}(\mathrm{on})} = f(T_{\mathrm{j}})$

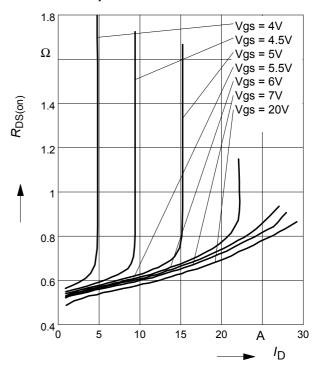
parameter : I_D = 9.4 A, V_{GS} = 10 V



6 Typ. drain-source on resistance

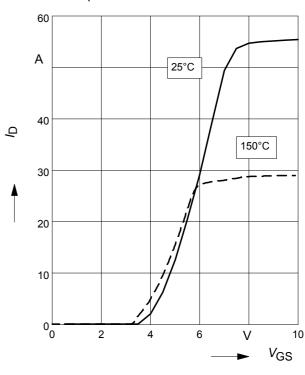
 $R_{\mathrm{DS(on)}} = f(I_{\mathrm{D}})$

parameter: T_i =150°C, V_{GS}



8 Typ. transfer characteristics

 $I_{\rm D}$ = $f(V_{\rm GS})$; $V_{\rm DS}$ $\geq 2 \times I_{\rm D} \times R_{\rm DS(on)max}$ parameter: $t_{\rm p}$ = 10 μ s



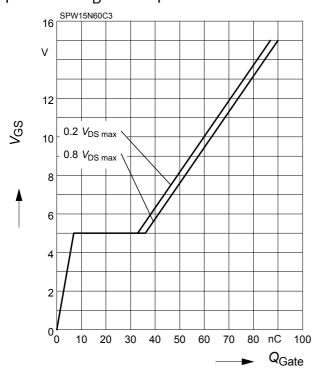
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9 Typ. gate charge

 $V_{GS} = f (Q_{Gate})$

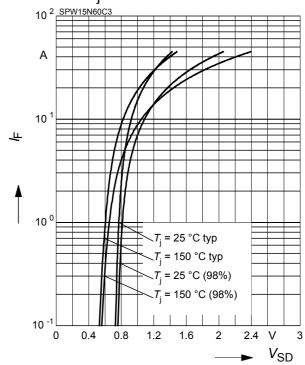
parameter: I_D = 15 A pulsed



10 Forward characteristics of body diode

 $I_{\mathsf{F}} = f(\mathsf{V}_{\mathsf{SD}})$

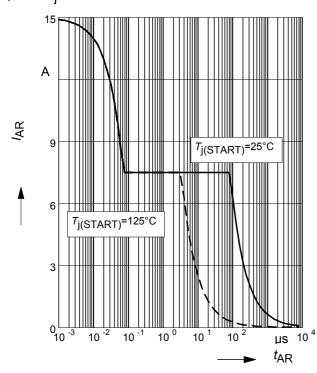
parameter: T_{j} , t_{p} = 10 μs



11 Avalanche SOA

 $I_{AR} = f(t_{AR})$

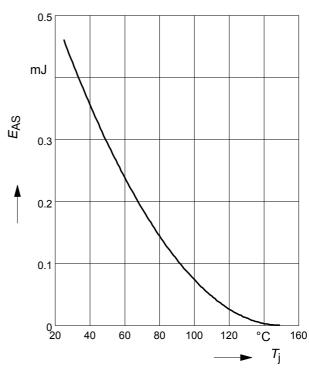
par.: $T_j \le 150 \,^{\circ}\text{C}$



12 Avalanche energy

 $E_{AS} = f(T_i)$

par.: $I_D = 7.5 \text{ A}, V_{DD} = 50 \text{ V}$

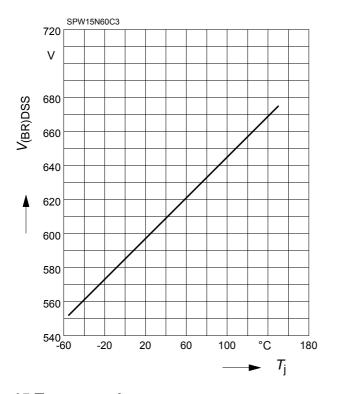


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13 Drain-source breakdown voltage

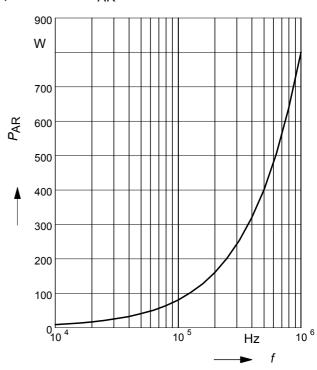
$$V_{(BR)DSS} = f(T_j)$$



14 Avalanche power losses

$$P_{AR} = f(f)$$

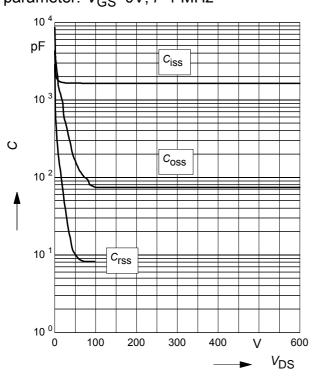
parameter: E_{AR}=0.8mJ



15 Typ. capacitances

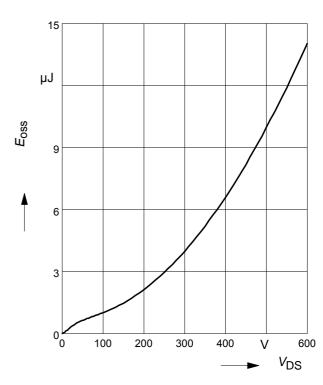
$$C = f(V_{DS})$$

parameter: V_{GS} =0V, f=1 MHz



16 Typ. $C_{\rm OSS}$ stored energy

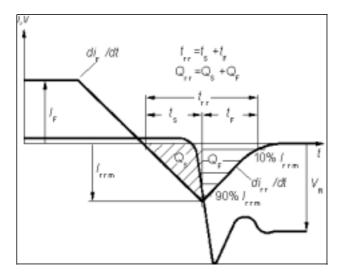
$$E_{\text{OSS}} = f(V_{\text{DS}})$$



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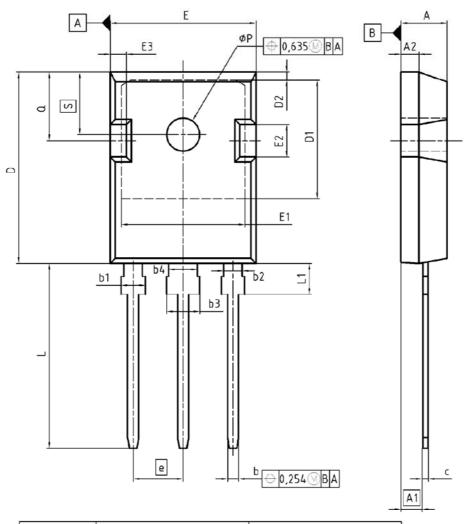


Definition of diodes switching characteristics

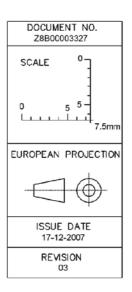




PG-TO-247-3-1



DIM	MILLIM	ETERS	INCHES	
DIM	MIN	MAX	MIN	MAX
Α	4.90	5.16	0.193	0.203
A1	2.27	2.53	0.089	0.099
A2	1.85	2.11	0.073	0.083
ь	1.07	1.33	0.042	0.052
b1	1.90	2.41	0.075	0.095
b2	1.90	2.16	0.075	0.085
b3	2.87	3.38	0.113	0.133
b4	2.87	3.13	0.113	0.123
С	0.55	0.68	0.022	0.027
D	20.82	21.10	0.820	0.831
D1	16.25	17.65	0.640	0.695
D2	1.05	1.35	0.041	0.053
E	15.70	16.03	0.618	0.631
E1	13.10	14.15	0.516	0.557
E2	3.68	5.10	0.145	0.201
E3	1.68	2.60	0.066	0.102
е	5.	44	0.2	14
N	(3	;	3
L	19.80	20.31	0.780	0.799
L1	4.17	4.47	0.164	0.176
øP	3.50	3.70	0.138	0.146
Q	5.49	6.00	0.216	0.236
S	6.04	6.30	0.238	0.248





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New package outlines TO-247

1 New package outlines TO-247

Assembly capacity extension for CoolMOSTM technology products assembled in lead-free package PG-TO247-3 at subcontractor ASE (Weihai) Inc., China (Changes are marked in blue.)

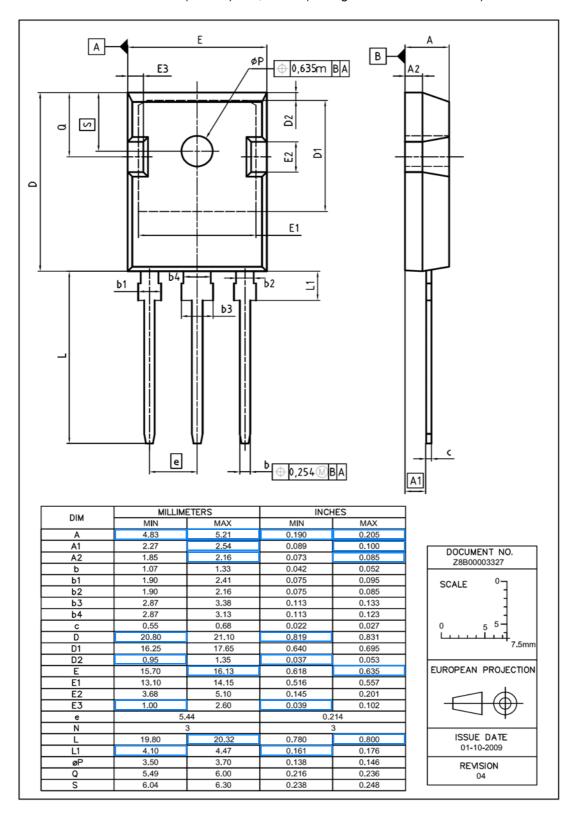


Figure 1 Outlines TO-247, dimensions in mm/inches

Final Data Sheet Erratum Rev. 2.0, 2010-02-01

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